



## Description

The IRFR5505TRPBF uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

## General Features

$V_{DS} = -60V$   $I_D = -15A$

$R_{DS(ON)} < 82m\Omega$  @  $V_{GS}=10V$

## Application

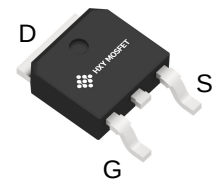
Battery protection

Load switch

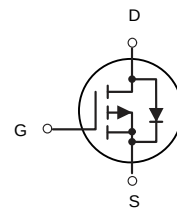
Uninterruptible power supply

## Ordering Information

| Product ID    | Pack                      | Brand      | Qty(PCS) |
|---------------|---------------------------|------------|----------|
| IRFR5505TRPBF | TO-252-2L(TO-252-2(DPAK)) | HXY MOSFET | 2500     |



TO-252-2L  
(TO-252-2(DPAK))



P-Channel MOSFET

## Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

| Symbol                | Parameter                                              | Rating     | Units        |
|-----------------------|--------------------------------------------------------|------------|--------------|
| $V_{DS}$              | Drain-Source Voltage                                   | -60        | V            |
| $V_{GS}$              | Gate-Source Voltage                                    | $\pm 20$   | V            |
| $I_D@T_C=25^\circ C$  | Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup> | -15        | A            |
| $I_D@T_C=100^\circ C$ | Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup> | -11        | A            |
| $I_{DM}$              | Pulsed Drain Current <sup>2</sup>                      | -36        | A            |
| EAS                   | Single Pulse Avalanche Energy <sup>3</sup>             | 35.4       | mJ           |
| $I_{AS}$              | Avalanche Current                                      | -26.6      | A            |
| $P_D@T_C=25^\circ C$  | Total Power Dissipation <sup>4</sup>                   | 34.7       | W            |
| $P_D@T_A=25^\circ C$  | Total Power Dissipation <sup>4</sup>                   | 2          | W            |
| $T_{STG}$             | Storage Temperature Range                              | -55 to 150 | $^\circ C$   |
| $T_J$                 | Operating Junction Temperature Range                   | -55 to 150 | $^\circ C$   |
| $R_{\theta JA}$       | Thermal Resistance Junction-Ambient <sup>1</sup>       | 62         | $^\circ C/W$ |
| $R_{\theta JC}$       | Thermal Resistance Junction-Case <sup>1</sup>          | 3.6        | $^\circ C/W$ |



**Electrical Characteristics ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)**

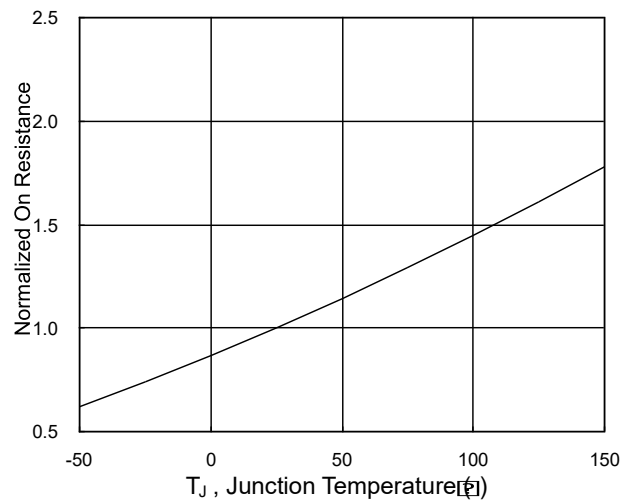
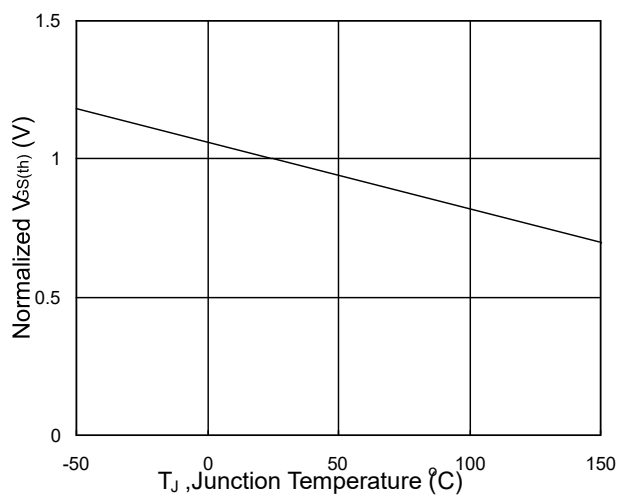
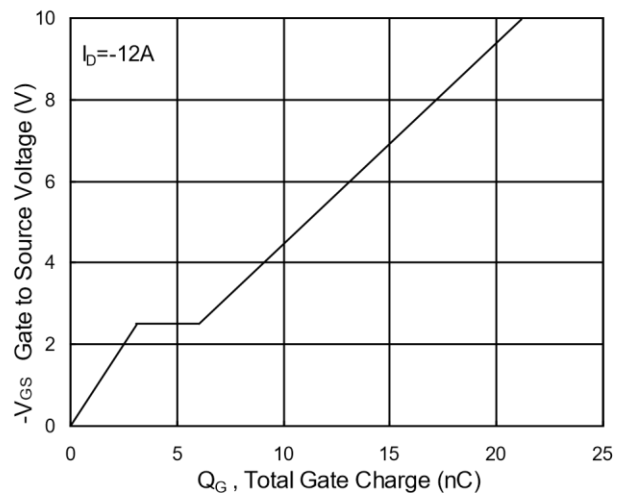
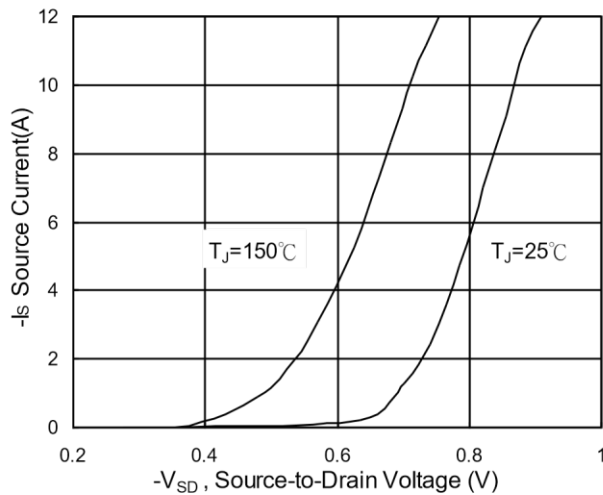
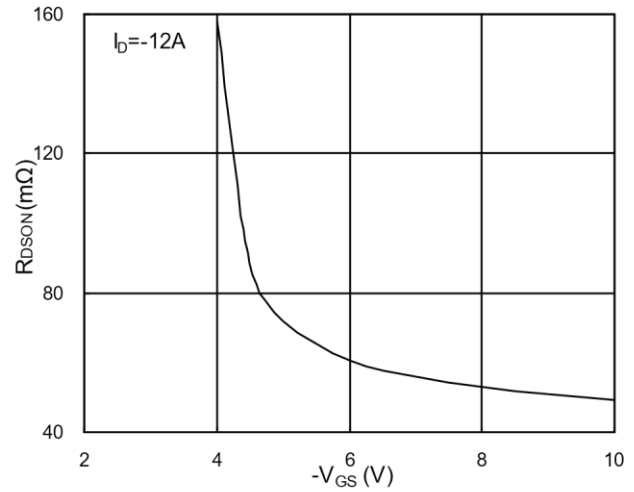
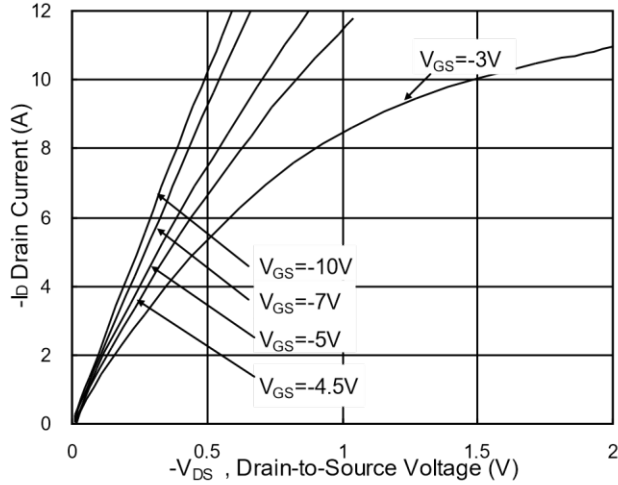
| Symbol                         | Parameter                                | Conditions                                                        | Min. | Typ.  | Max.      | Unit                   |
|--------------------------------|------------------------------------------|-------------------------------------------------------------------|------|-------|-----------|------------------------|
| $BV_{DSS}$                     | Drain-Source Breakdown Voltage           | $V_{GS}=0V$ , $I_D=-250\mu A$                                     | -60  | ---   | ---       | V                      |
| $\Delta BV_{DSS} / \Delta T_J$ | $BV_{DSS}$ Temperature Coefficient       | Reference to $25^{\circ}\text{C}$ , $I_D=-1mA$                    | ---  | -0.03 | ---       | V/ $^{\circ}\text{C}$  |
| $R_{DS(on)}$                   | Static Drain-Source On-Resistance        | $V_{GS}=-10V$ , $I_D=-12A$                                        | ---  | 70    | 82        | m $\Omega$             |
|                                |                                          | $V_{GS}=-4.5V$ , $I_D=-8A$                                        | ---  | 85    | 105       |                        |
| $V_{GS(th)}$                   | Gate Threshold Voltage                   | $V_{GS}=V_{DS}$ , $I_D=-250\mu A$                                 | -1.2 | 1.5   | -2.5      | V                      |
| $\Delta V_{GS(th)}$            | $V_{GS(th)}$ Temperature Coefficient     |                                                                   | ---  | 4.56  | ---       | mV/ $^{\circ}\text{C}$ |
| $I_{DSS}$                      | Drain-Source Leakage Current             | $V_{DS}=-48V$ , $V_{GS}=0V$ , $T_J=25^{\circ}\text{C}$            | ---  | ---   | 1         | $\mu A$                |
|                                |                                          | $V_{DS}=-48V$ , $V_{GS}=0V$ , $T_J=55^{\circ}\text{C}$            | ---  | ---   | 5         |                        |
| $I_{GSS}$                      | Gate-Source Leakage Current              | $V_{GS}=\pm 20V$ , $V_{DS}=0V$                                    | ---  | ---   | $\pm 100$ | nA                     |
| $g_{fs}$                       | Forward Transconductance                 | $V_{DS}=-5V$ , $I_D=-12A$                                         | ---  | 15.4  | ---       | S                      |
| $R_g$                          | Gate Resistance                          | $V_{DS}=0V$ , $V_{GS}=0V$ , $f=1MHz$                              | ---  | 13.5  | ---       | $\Omega$               |
| $Q_g$                          | Total Gate Charge (-4.5V)                | $V_{DS}=-48V$ , $V_{GS}=-4.5V$ , $I_D=-10A$                       | ---  | 9.86  | ---       | nC                     |
| $Q_{gs}$                       | Gate-Source Charge                       |                                                                   | ---  | 3.08  | ---       |                        |
| $Q_{gd}$                       | Gate-Drain Charge                        |                                                                   | ---  | 2.95  | ---       |                        |
| $T_{d(on)}$                    | Turn-On Delay Time                       | $V_{DD}=-15V$ , $V_{GS}=-10V$ ,<br>$R_G=3.3\Omega$ ,<br>$I_D=-1A$ | ---  | 28.8  | ---       | ns                     |
| $T_r$                          | Rise Time                                |                                                                   | ---  | 19.8  | ---       |                        |
| $T_{d(off)}$                   | Turn-Off Delay Time                      |                                                                   | ---  | 60.8  | ---       |                        |
| $T_f$                          | Fall Time                                |                                                                   | ---  | 7.2   | ---       |                        |
| $C_{iss}$                      | Input Capacitance                        | $V_{DS}=-15V$ , $V_{GS}=0V$ , $f=1MHz$                            | ---  | 1447  | ---       | pF                     |
| $C_{oss}$                      | Output Capacitance                       |                                                                   | ---  | 97.3  | ---       |                        |
| $C_{rss}$                      | Reverse Transfer Capacitance             |                                                                   | ---  | 70    | ---       |                        |
| $I_S$                          | Continuous Source Current <sup>1,5</sup> | $V_G=V_D=0V$ , Force Current                                      | ---  | ---   | -18       | A                      |
| $I_{SM}$                       | Pulsed Source Current <sup>2,5</sup>     |                                                                   | ---  | ---   | -36       | A                      |
| $V_{SD}$                       | Diode Forward Voltage <sup>2</sup>       | $V_{GS}=0V$ , $I_S=-1A$ , $T_J=25^{\circ}\text{C}$                | ---  | ---   | -1.2      | V                      |

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper.
2. The data tested by pulsed , pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$
3. The EAS data shows Max. rating . The test condition is  $V_{DD}=-25V$ ,  $V_{GS}=-10V$ ,  $L=0.1mH$ ,  $I_{AS}=-26.6A$
4. The power dissipation is limited by  $150^{\circ}\text{C}$  junction temperature
5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications , should be limited by total power dissipation.



### Typical Characteristics



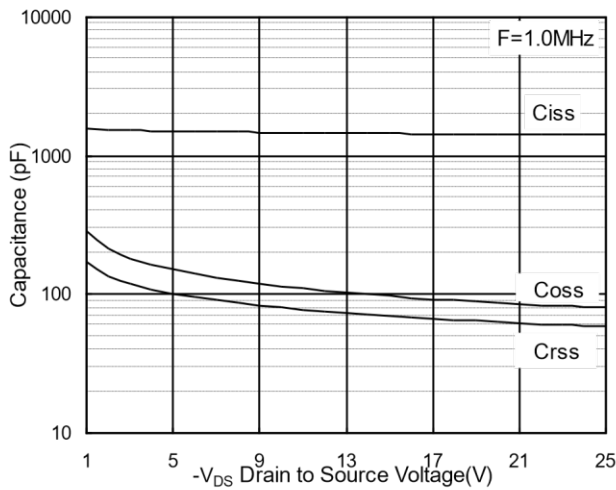


Fig.7 Capacitance

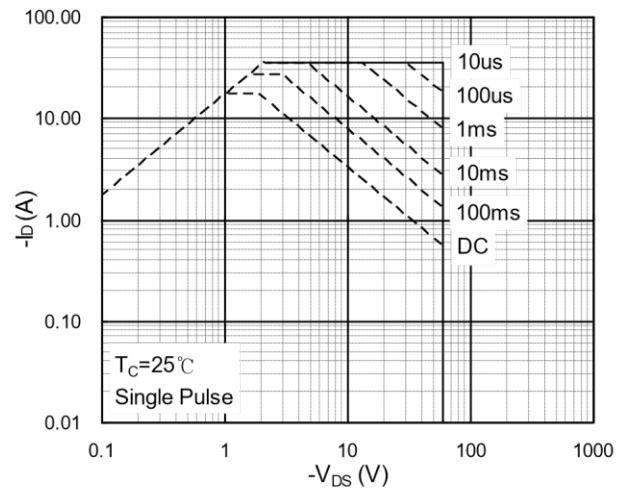


Fig.8 Safe Operating Area

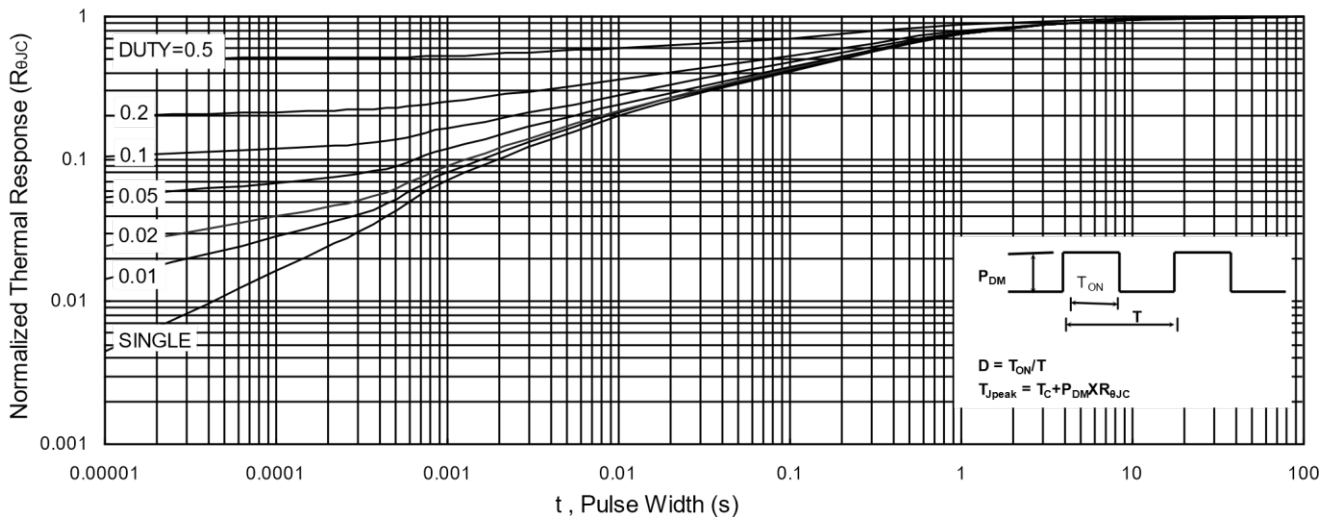


Fig.9 Normalized Maximum Transient Thermal Impedance

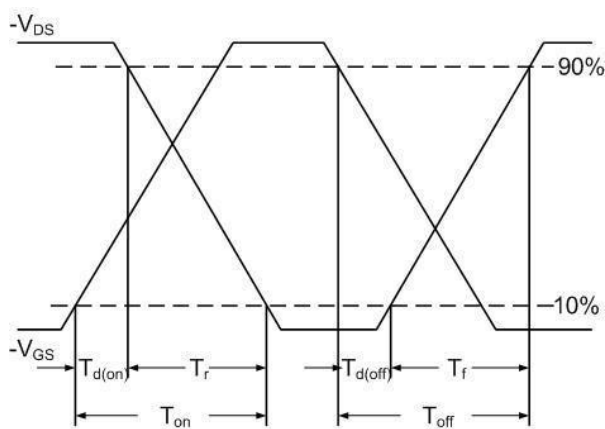


Fig.10 Switching Time Waveform

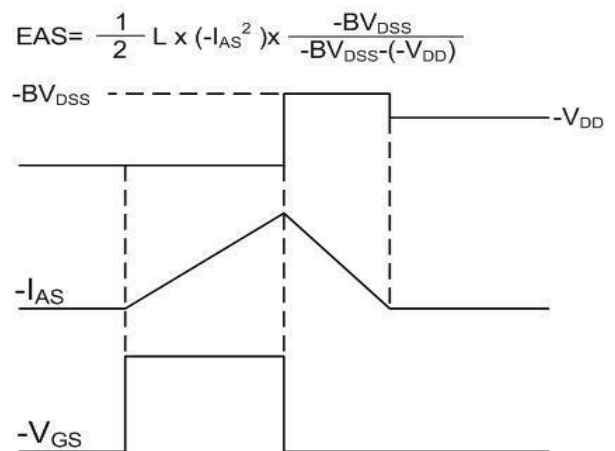
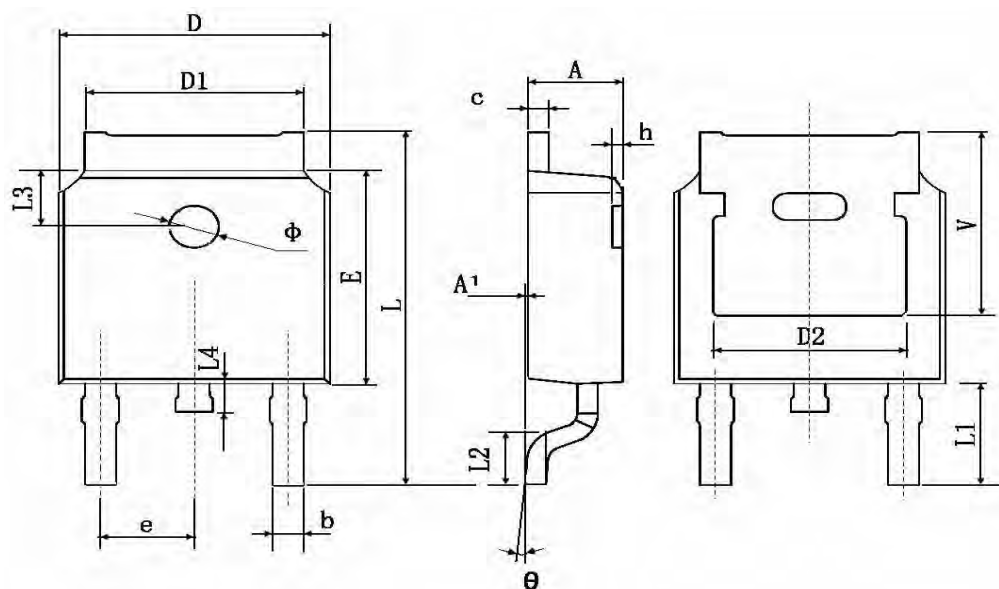


Fig.11 Unclamped Inductive Waveform



## TO-252-2L(TO-252-2(DPAK)) Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |
|--------|---------------------------|--------|----------------------|-------|
|        | Min.                      | Max.   | Min.                 | Max.  |
| A      | 2.200                     | 2.400  | 0.087                | 0.094 |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |
| b      | 0.660                     | 0.860  | 0.026                | 0.034 |
| c      | 0.460                     | 0.580  | 0.018                | 0.023 |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |
| D2     | 4.830 TYP.                |        | 0.190 TYP.           |       |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |
| e      | 2.186                     | 2.386  | 0.086                | 0.094 |
| L      | 9.800                     | 10.400 | 0.386                | 0.409 |
| L1     | 2.900 TYP.                |        | 0.114 TYP.           |       |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |
| L3     | 1.600 TYP.                |        | 0.063 TYP.           |       |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |
| Φ      | 1.100                     | 1.300  | 0.043                | 0.051 |
| θ      | 0°                        | 8°     | 0°                   | 8°    |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |
| V      | 5.350 TYP.                |        | 0.211 TYP.           |       |



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